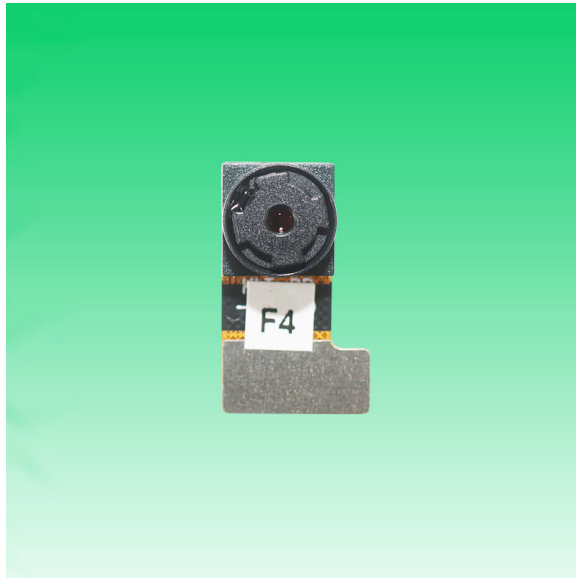
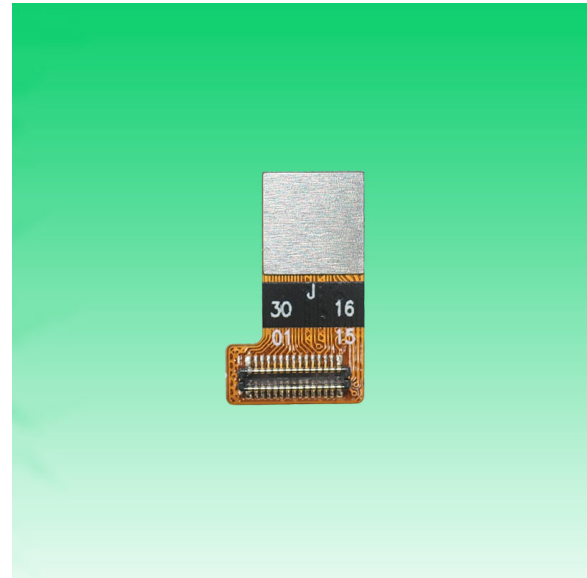


KLT-RP-IMX219 V5.0**8MP Sony IMX219 MIPI Interface Fixed Focus Camera Module**

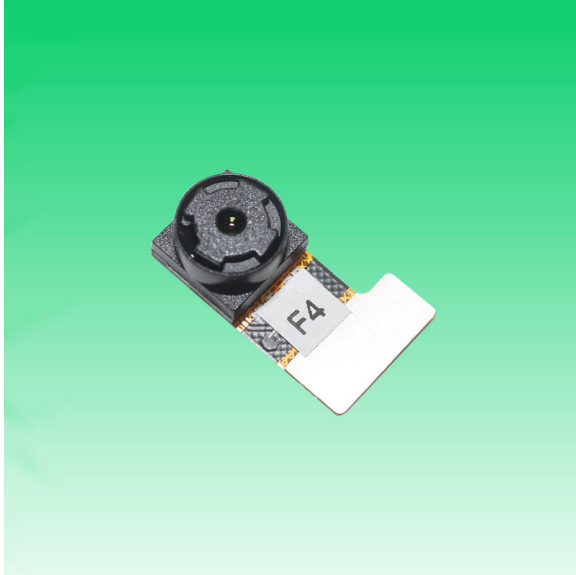
Front View



Back View

Specifications

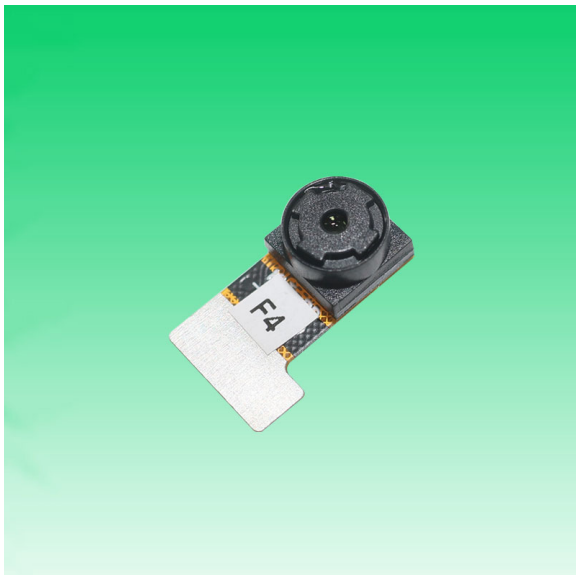
Camera Module No.	KLT-RP-IMX219 V5.0
Resolution	8MP
Image Sensor	IMX219
Sensor Type	1/4"
Pixel Size	1.12 μm x 1.12 μm
EFL	2.93 mm
F.NO	2.00
Pixel	3264 x 2448
View Angle	75.0°(DFOV) 62.8°(HFOV) 49.3°(VFOV)
Lens Dimensions	6.50 x 6.50 x 4.70 mm
Module Size	14.80 x 8.85 mm
Module Type	Fixed Focus
Interface	MIPI
Auto Focus VCM Driver IC	None
Lens Type	650nm IR Cut
Operating Temperature	-20°C to +60°C
Mating Connector	DF37NB-30DS-0.4V

KLT-RP-IMX219 V5.0**8MP Sony IMX219 MIPI Interface Fixed Focus Camera Module**

Top View



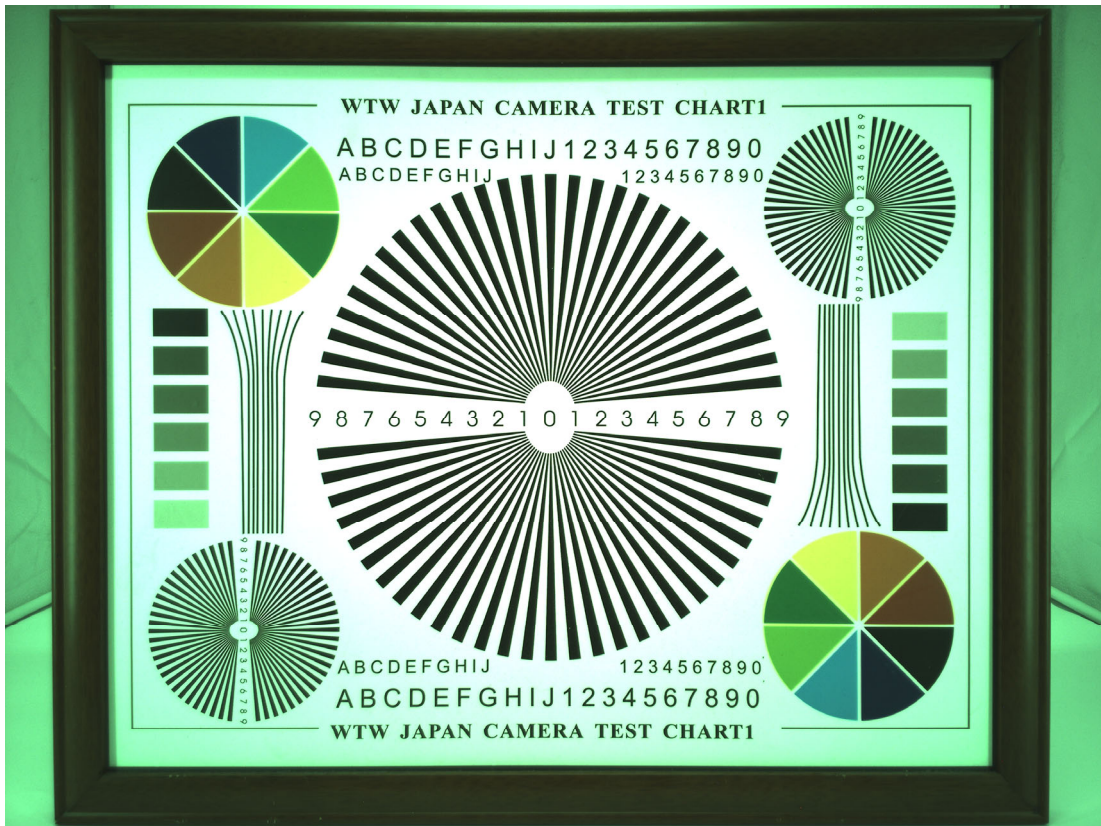
Side View

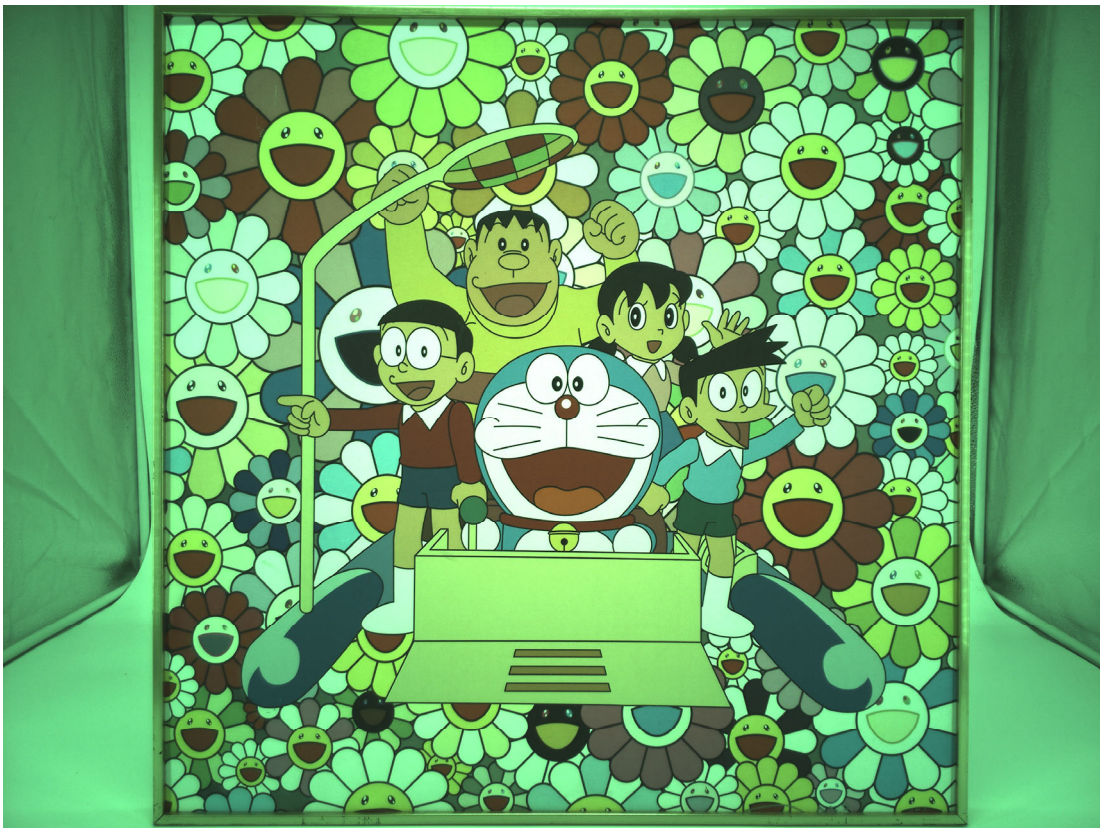


Bottom View





Mating Connector





Periodic table of Elements

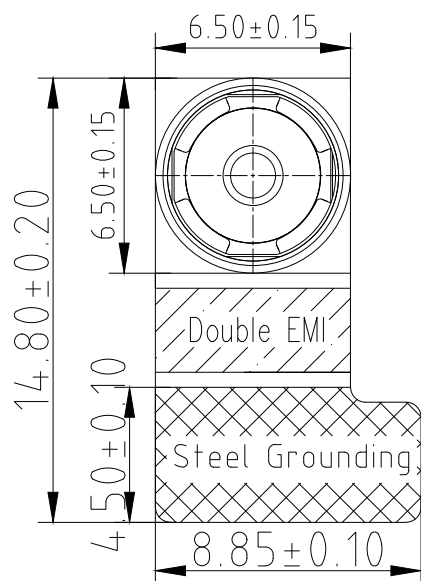
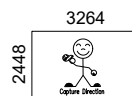
GROUP 1	1,008	H	Hydrogen (Gas)	Other Metals	Noble Gases	Average Atomic Mass	2	4,002	He	Helium
2	6,941	Li	Lithium	Alkali Metals	Metalloids	Atomic Number	3	9,01	Be	Beryllium
11	22,99	Na	Sodium	Alkaline Earth Metals	Non-metals	Name	12	24,31	Mg	Magnesium
12	24,31	Mg	Magnesium	Transition Metals	Halogens	Symbol	13	26,98	Al	Aluminum
19	39,09	K	Potassium				14	28,08	Si	Silicon
20	40,08	Ca	Calcium				15	30,97	P	Phosphorus
21	44,95	Sc	Scandium				16	32,07	S	Sulfur
22	47,87	Ti	Titanium				17	35,45	Cl	Chlorine
23	50,94	V	Vanadium				18	39,95	Ar	Argon
24	51,99	Cr	Chromium				31	69,72	Ga	Gallium
25	54,94	Mn	Manganese				32	72,61	Ge	Germanium
26	55,85	Fe	Iron				33	74,92	As	Arsenic
27	58,93	Co	Cobalt				34	78,96	Se	Selenium
28	58,69	Ni	Nickel				35	126,9	Br	Bromine
29	63,55	Cu	Copper				36	131,3	Kr	Krypton
30	65,39	Zn	Zinc				37	186,9	Hg	Mercury
31	69,72	Ga	Gallium				38	200,6	Pb	Lead
32	72,61	Ge	Germanium				39	208,9	Bi	Bismuth
33	74,92	As	Arsenic				40	209	Po	Polonium
34	78,96	Se	Selenium				41	210	At	Astatine
35	126,9	Br	Bromine				42	210	Rn	Radon
36	131,3	Kr	Krypton				43	210	Fr	Francium
37	186,9	Hg	Mercury				44	210	Ra	Radium
38	200,6	Pb	Lead				45	210	Ac	Actinium
39	208,9	Bi	Bismuth				46	210	Th	Thorium
40	209	Po	Polonium				47	210	Pa	Protactinium
41	210	At	Astatine				48	210	U	Uranium
42	210	Rn	Radon				49	210	Np	Neptunium
43	210	Fr	Francium				50	210	Pu	Plutonium
44	210	Ra	Radium				51	210	Am	Americium
45	210	Ac	Actinium				52	210	Cm	Curium
46	210	Th	Thorium				53	210	Bk	Berkelium
47	210	Pa	Protactinium				54	210	Cf	Californium
48	210	U	Uranium				55	210	Es	Einsteinium
49	210	Np	Neptunium				56	210	Fm	Fermium
50	210	Pu	Plutonium				57	210	Md	Mendelevium
51	210	Am	Americium				58	210	No	Nobelium
52	210	Cm	Curium				59	210	Lr	Lawrencium
53	210	Bk	Berkelium				60	210		
54	210	Cf	Californium				61	210		
55	210	Es	Einsteinium				62	210		
56	210	Fm	Fermium				63	210		
57	210	Md	Mendelevium				64	210		
58	210	No	Nobelium				65	210		
59	210	Lr	Lawrencium				66	210		
60	210						67	210		
61	210						68	210		
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63	210						70	210		
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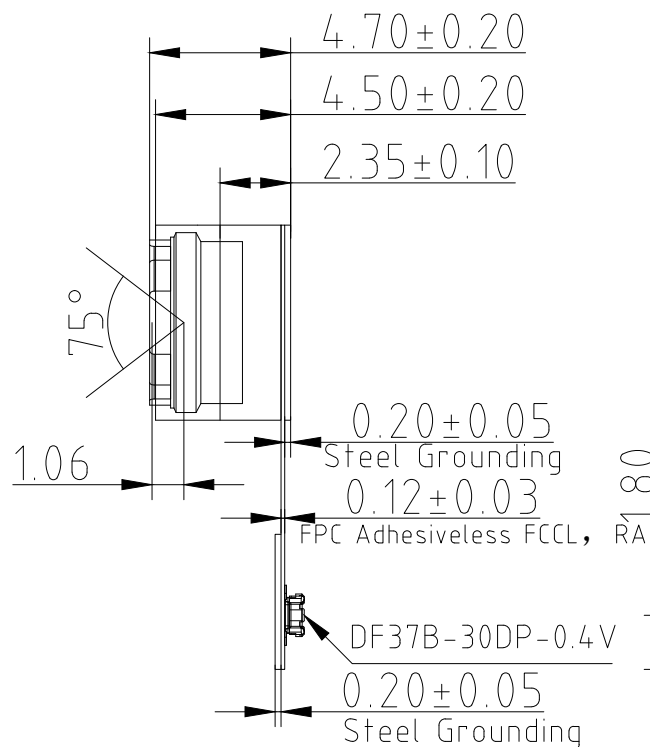
RoHS

PIN SIGNAL

1	NC
2	NC
3	DOVDD1.8V
4	DVDD1.2V
5	NC
6	DGND
7	XCLK
8	DGND
9	AGND
10	AVDD2.8V
11	NC
12	DGND
13	MDP3
14	MDN3
15	DGND
16	DGND
17	MDN2
18	MDP2
19	DGND
20	MDN1
21	MDP1
22	DGND
23	MDN0
24	MDP0
25	DGND
26	MCN
27	MCP
28	PWDN
29	SCL
30	SDA

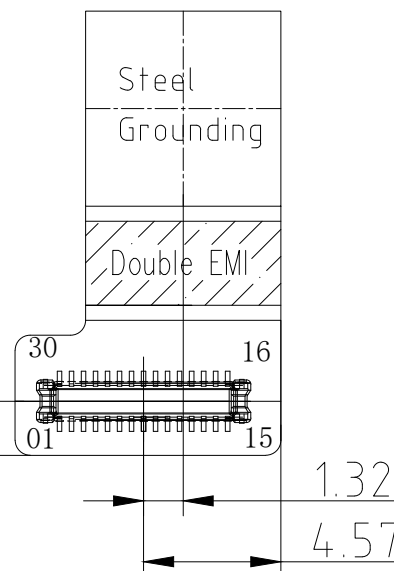


TOP VIEW



SIDE VIEW

Version	Information
V1.0	First Version
V2.0	Change layout
V3.0	Change lens
V4.0	Change lens holder
V5.0	Change capture direction



BOTTOM VIEW

NOTE:

1.The device slave address:0x20(w);0x21(r)

Parameters:

1、Sensor specification:

Image Sensor: IMX219

Pixel: 1.12um×1.12um

Lens Type: 1/4

Important Voltage Description: DVDD1.2V
(external power supply);

2、Lens specification:

FOV: 75°(D);62.8°(H);49.3°(V)

F/NO.: 2.0

TV distortion: <1.0%

Focal length: 2.93mm

Composition: 4P+IR FILTER

IR Cut Coating: 650nm±10nm@50%

Kai Lap Technologies Group Ltd

Designed By

Kevin

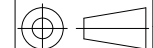
Model Name:

KLT-RP-IMX219 V5.0

Checked By

Jacky

Projection Type:



Third Angle

Unit:

mm

Scale:

1:1

Date:

12/30/2024

Sheet:

1 of 1

Version:

1/0

[Product Brief]

Ver.1.0

IMX219PQ

Diagonal 4.60mm (Type 1/4.0) 8M Pixel CMOS Image Sensor with Square Pixel for Color Cameras

Description

IMX219PQ is a diagonal 4.60mm (Type 1/4.0) CMOS active pixel type image sensor with a square pixel array and 8.08M effective pixels. This chip operates with three power supplies, analogue 2.8V, digital 1.2 V, and IF 1.8 V, and has low power consumption. High sensitivity, low dark current, and no smear are achieved through the adoption of R, G, and B primary color pigment mosaic filters. This chip features an electronic shutter with variable charge-storage time.

In addition, this product is designed for use in cellular phone and tablet pc. When using this for another application, Sony does not guarantee the quality and reliability of product. Therefore, don't use this for applications other than cellular phone and tablet pc. Consult your Sony sales representative if you have any questions.

Functions and Features

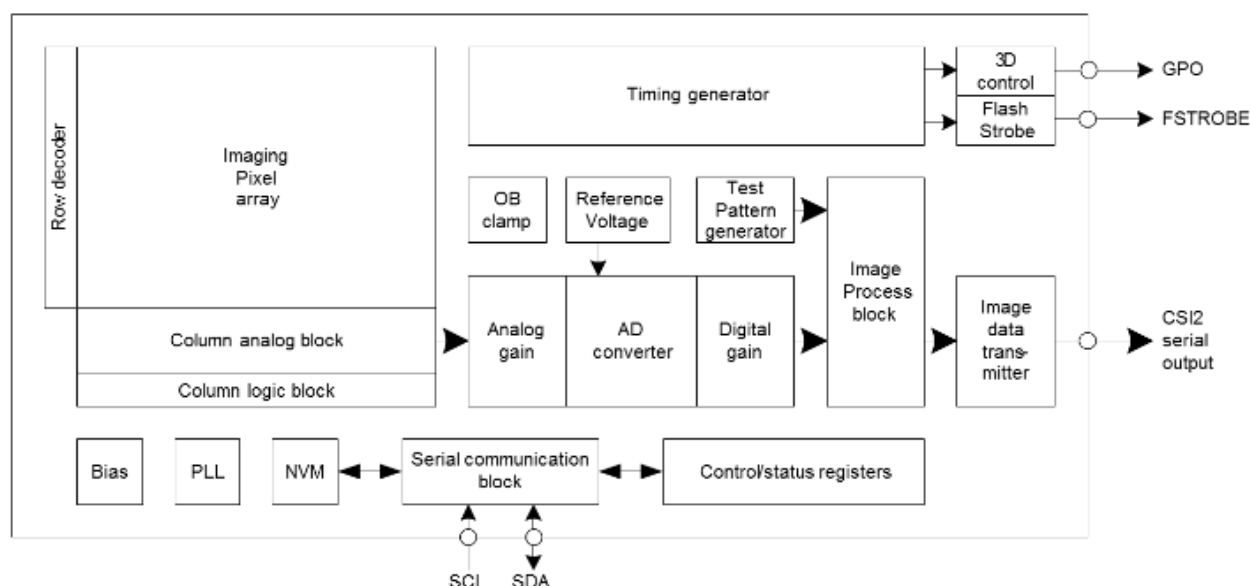
- ◆ Back-illuminated CMOS image sensor Exmor R™
- ◆ 2-wire serial communication circuit on chip
- ◆ CSI2 serial data output (selection of 4lane/2lane)
- ◆ Timing generator, H and V driver circuits on chip
- ◆ CDS/PGA on chip
- ◆ 10-bit A/D converter on chip
- ◆ Automatic optical black (OB) clamp circuit on chip
- ◆ PLL on chip (rectangular wave)
- ◆ High sensitivity, low dark current, no smear
- ◆ Excellent anti-blooming characteristics
- ◆ Variable-speed shutter function (1 H units)
- ◆ R, G, B primary color pigment mosaic filters on chip
- ◆ Max. 30frame/s in all-pixel scan mode
- ◆ Pixel rate: 280 [Mpixel/s] (All-pixels mode)
- ◆ 180 frame/s @720p with 2x2 analog (special) binning, 60 frame/s @1080p with V-crop
- ◆ Datarate: Max.755Mbps/lane (@4lane), 912Mbps/Lane(@2lane)

Device Structure

◆ CMOS image sensor	
◆ Image size	: Diagonal 4.60mm (Type 1/4.0)
◆ Total number of pixels	: 3296(H) × 2512(V) approx. 8.28M pixels
◆ Number of effective pixels	: 3296(H) × 2480(V) approx. 8.17M pixels
◆ Number of active pixels	: 3280(H) × 2464(V) approx. 8.08M pixels
◆ Chip size	: 5.095mm (H) × 4.930mm (V) (w/ Scribe)
◆ Unit cell size	: 1.12μm (H) × 1.12μm (V)
◆ Substrate material	: Silicon

Functional Description

Block diagram



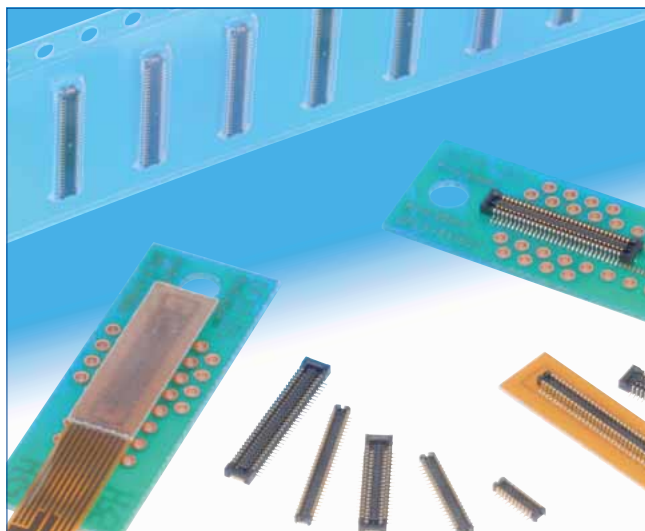
Exmor R

* Exmor R is a trademark of Sony Corporation. The Exmor R is a Sony's CMOS image sensor with significantly enhanced imaging characteristics including sensitivity and low noise by changing fundamental structure of Exmor™ pixel adopted column parallel A/D converter to back-illuminated type.

Sony reserves the right to change products and specifications without prior notice.

This information does not convey any license by any implication or otherwise under any patents or other right.

Application circuits shown, if any, are typical examples illustrating the operation of the devices. Sony cannot assume responsibility for any problems arising out of the use of these circuits.



■Features

1. Reduced size and board-occupied area

With the mated height of 0.98/1.5mm, width of 2.98mm and length of 8.22mm (30 positions) the connectors are one of the smallest in its class. Also 2.6mm depth short-lead type is available. (Fig.1) Sufficiently large flat areas allow pick-up with vacuum nozzles of automatic placement equipment.

2. Reliable electrical and mechanical connection

Despite its small mated height, unique contact configuration, with a 2-point contacts and effective mating length of 0.25mm, assures highly reliable connection while confirming a complete mating with a definite tactile feel.

3. Self alignment

Recognizing the difficulties of mating extremely small connectors in limited spaces, the connectors will self-align within 0.3mm.

4. Physical shock and vibration protection

2-point contact assures electrical connection in a shock or vibration applications. (Fig.2)

5. Solder wicking prevention

Nickel barriers (receptacles) and unique forming of the contacts (headers) prevent un-intentional solder wicking.

6. Contamination protection

Insulator walls protect the contact areas against flux splatter or other physical particles contamination. (Fig.3)

■Further reduction of the board space.

●Comparison of board mounting space

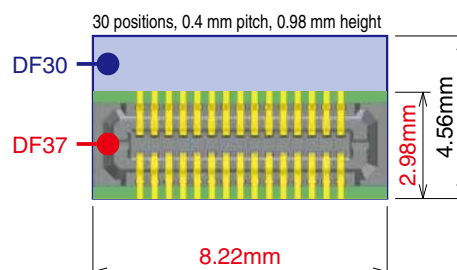


Fig.1

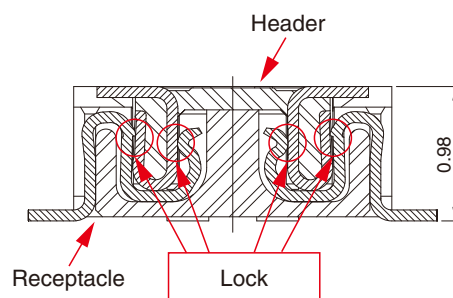
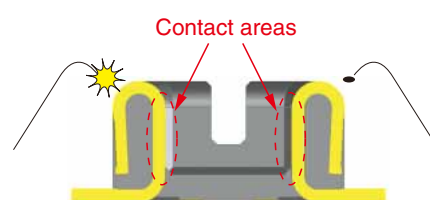


Fig.2

●Splatter protection



Contact areas are not exposed to the outside penetration of the flux or other physical particles.

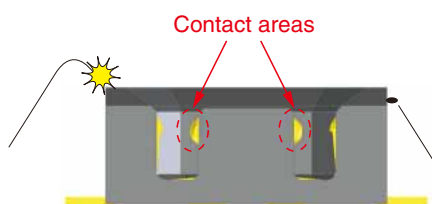


Fig.3

Product Specifications

Ratings	Current rating	0.3A	Operating temperature range	-35°C to +85°C (Note 1)	Storage temperature range	-10°C to +60°C (Note 2)
	Voltage rating	30V AC, DC	Operating humidity range	RH 20% to 80%	Storage humidity range	RH 40% to 70% (Note 2)

Item	Specification	Conditions
1. Insulation resistance	50MΩ min	100V DC
2. Withstanding voltage	No flashover or insulation breakdown	100V AC / 1 minute
3. Contact resistance	100mΩ max.	20mV AC, 1kHz, 1mA
4. Vibration	No electrical discontinuity of 1μs or longer No damage or parts dislocation	Frequency : 10 to 55 Hz, single amplitude of 0.75 mm, 2 hours, 3 axis
5. Humidity	Contact resistance : 100mΩ max., Insulation resistance : 25MΩ min.	96 hours at 40 ±2°C and humidity of 90 to 95% No damage or parts dislocation
6. Temperature cycle	Contact resistance : 100mΩ max., Insulation resistance : 50MΩ min. No damage or parts dislocation	-55°C → 5 to 35°C → 85°C → 5 to 35°C Time: 30 min. → 10 min. → 30 min. → 10 min. 5 cycles
7. Durability	Contact resistance : 100mΩ max.	10 cycles
8. Resistance to soldering heat	No deformation of components affecting performance	Reflow : At the recommended temperature profile Manual soldering : 350°C for 3 seconds

Note 1 : Includes temperature rise caused by current flow.

Note 2 : The term "storage" here refers to products stored for a long period prior to board mounting and use.

The operating temperature and humidity range covers the non-conducting condition of connectors after board mounting and the temporary storage conditions of transportation, etc.

Materials / Finish

Receptacle

Part	Material	Finish	Remarks
Insulator	LCP	Color: Black	UL94V-0

Header

Part	Material	Finish	Remarks
Contacts	Phosphor bronze	Gold plated	—

Product Number Structure

Refer to the chart below when determining the product specifications from the product number.

Please select from the product numbers listed in this catalog when placing orders.

●Receptacles

DF 37 # - () - * DS - 0.4 V (**)**

① ② ③ ④ ⑤ ⑥ ⑦ ⑧

① Series name : DF37	⑤ Connector style DS : Receptacle
② Configuration NB : With metal fittings NC : Without metal fittings SB : Short-lead type with metal fittings	⑥ Contact pitch : 0.4mm
③ Stacking height Blank : 0.98mm, 1.5 : 1.5mm	⑦ Terminal type V : SMT vertical mount
④ Number of contacts	⑧ Packaging (51) Stacking height 0.98mm : Embossed tape packaging (8,000 pcs/reel) (51) Stacking height 1.5mm : Embossed tape packaging (5,000 pcs/reel) (53) : Embossed tape packaging (1,000 pcs/reel)

●Headers

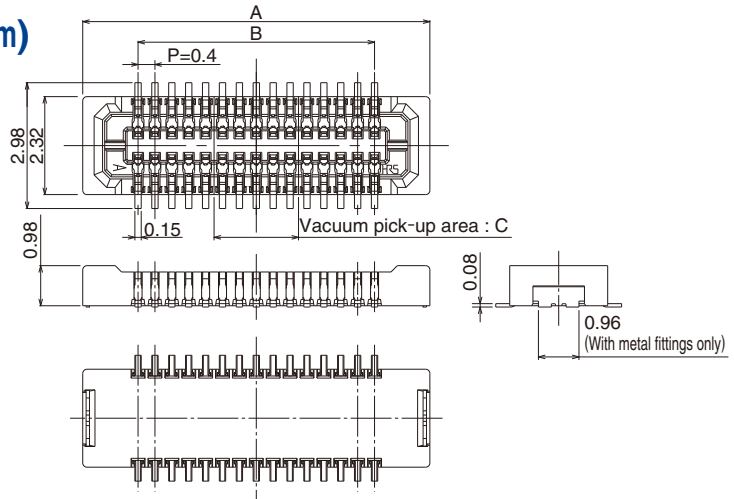
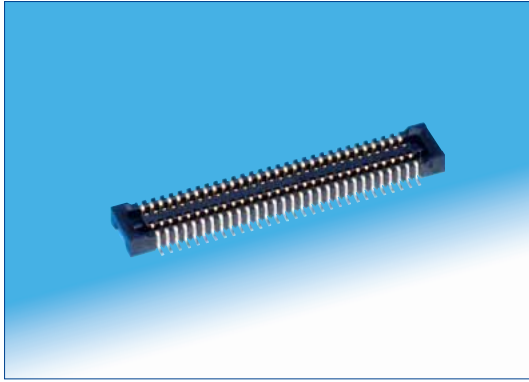
DF 37 # - * DP - 0.4 V ()**

① ② ③ ④ ⑤ ⑥ ⑦

① Series name : DF37	④ Connector style DP : Header
② Configuration B : With metal fittings C : Without metal fittings	⑤ Contact pitch : 0.4mm
③ Number of contacts	⑥ Terminal type V : SMT vertical mount
	⑦ Packaging (51) : Embossed tape packaging (8,000 pcs/reel) (53) : Embossed tape packaging (1,000 pcs/reel)

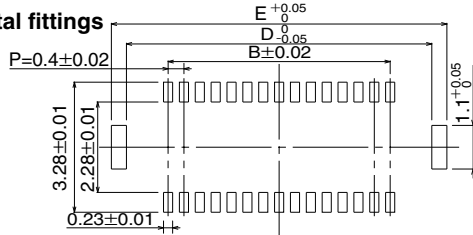
Note : The short-lead type is only available for the receptacle side (with hardware).

Receptacles (Stacking Height=0.98mm)

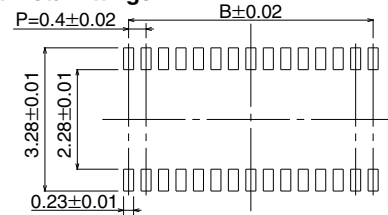


Recommended metal mask dimensions

With metal fittings

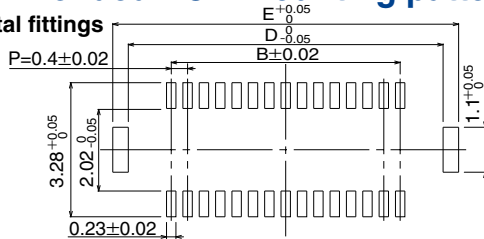


Without metal fittings

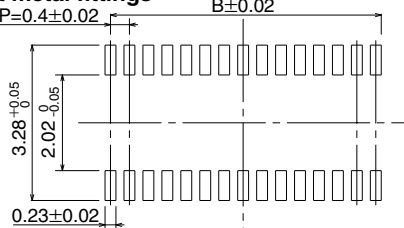


Recommended PCB mounting pattern

With metal fittings



Without metal fittings



With metal fittings

Unit : mm

Part No.	HRS No.	No. of Contacts	A	B	C	D	E
DF37NB-10DS-0.4V(51)	684-3301-6 51	10	4.22	1.6	0.8	3.7	4.46
DF37NB-16DS-0.4V(51)	684-3302-9 51	16	5.42	2.8	1.2	4.9	5.66
DF37NB-20DS-0.4V(51)	684-3303-1 51	20	6.22	3.6	1.6	5.7	6.46
DF37NB-24DS-0.4V(51)	684-3304-4 51	24	7.02	4.4	2	6.5	7.26
DF37NB-30DS-0.4V(51)	684-3305-7 51	30	8.22	5.6		7.7	8.46
DF37NB-34DS-0.4V(51)	684-3082-4 51	34	9.02	6.4	2.4	8.5	9.26
DF37NB-40DS-0.4V(51)	684-3306-0 51	40	10.22	7.6		9.7	10.46
DF37NB-44DS-0.4V(51)	684-3407-7 51	44	11.02	8.4	2.8	10.5	11.26
DF37NB-50DS-0.4V(51)	684-3307-2 51	50	12.22	9.6		11.7	12.46
DF37NB-60DS-0.4V(51)	684-3308-5 51	60	14.22	11.6	3.2	13.7	14.46
DF37NB-70DS-0.4V(51)	684-3409-2 51	70	16.22	13.6	3.6	15.7	16.46

Without metal fittings

Unit : mm

Part No.	HRS No.	No. of Contacts	A	B	C
DF37NC-10DS-0.4V(51)	684-3309-8 51	10	4.22	1.6	0.8
DF37NC-16DS-0.4V(51)	684-3310-7 51	16	5.42	2.8	1.2
DF37NC-20DS-0.4V(51)	684-3311-0 51	20	6.22	3.6	1.6
DF37NC-24DS-0.4V(51)	684-3312-2 51	24	7.02	4.4	2
DF37NC-30DS-0.4V(51)	684-3313-5 51	30	8.22	5.6	
DF37NC-34DS-0.4V(51)	684-3083-7 51	34	9.02	6.4	2.4
DF37NC-40DS-0.4V(51)	684-3314-8 51	40	10.22	7.6	
DF37NC-44DS-0.4V(51)	684-3324-1 51	44	11.02	8.4	2.8
DF37NC-50DS-0.4V(51)	684-3315-0 51	50	12.22	9.6	
DF37NC-60DS-0.4V(51)	684-3316-3 51	60	14.22	11.6	3.2
DF37NC-70DS-0.4V(51)	684-3084-0 51	70	16.22	13.6	3.6

Note 1 : Tape and reel packaging (8,000 pcs/reel). Order by number of reels.

Note 2 : This connector is NOT polarized.

Cameras Applications



Automotive Driver Pilot



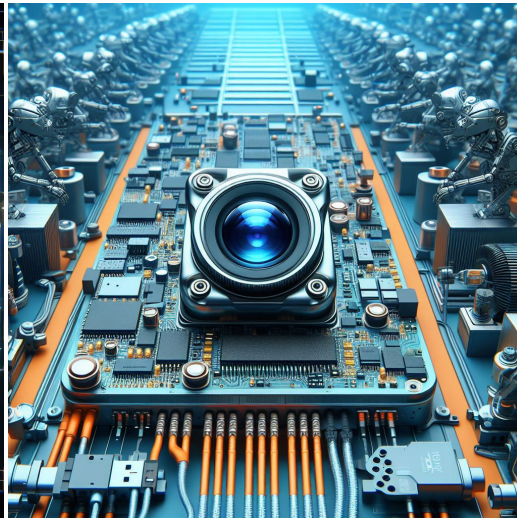
Live Streaming



Video Conference



Eye Tracker Biometric Detection



Machine Vision



Agricultural Monitor



Night Vision Security



Drone and Sports Eagle Eyes



Interactive Pet Camera

Cameras Applications

your BEST camera module partner



IMAGING DEVICES



Camera Module Pinout Definition Reference Chart

OmniVision Sony Samsung On-Semi Aptina Himax GalaxyCore PixArt SmartSens Sensors	
Pin Signal	Description
DGND GND	ground for digital circuit
AGND	ground for analog circuit
PCLK DCK	DVP PCLK output
XCLR PWDN XSHUTDOWN STANDBY	power down active high with internal pull-down resistor
MCLK XVCLK XCLK INCK	system input clock
RESET RST	reset active low with internal pull-up resistor
NC NULL	no connect
SDA SIO_D SIOD	SCCB data
SCL SIO_C SIOC	SCCB input clock
VSYNC XVS FSYNC	DVP VSYNC output
HREF XHS	DVP HREF output
DOVDD	power for I/O circuit
AFVDD	power for VCM circuit
AVDD	power for analog circuit
DVDD	power for digital circuit
STROBE FSTROBE	strobe output
FSIN	synchronize the VSYNC signal from the other sensor
SID	SCCB last bit ID input
ILPWM	mechanical shutter output indicator
FREX	frame exposure / mechanical shutter
GPIO	general purpose inputs
SLASEL	I2C slave address select
AFEN	CEN chip enable active high on VCM driver IC
MIPI Interface	
MDN0 DN0 MD0N DATA_N DMO1N	MIPI 1st data lane negative output
MDP0 DP0 MD0P DATA_P DMO1P	MIPI 1st data lane positive output
MDN1 DN1 MD1N DATA2_N DMO2N	MIPI 2nd data lane negative output
MDP1 DP1 MD1P DATA2_P DMO2P	MIPI 2nd data lane positive output
MDN2 DN2 MD2N DATA3_N DMO3N	MIPI 3rd data lane negative output
MDP2 DP2 MD2P DATA3_P DMO3P	MIPI 3rd data lane positive output
MDN3 DN3 MD3N DATA4_N DMO4N	MIPI 4th data lane negative output
MDP3 DP3 MD3P DATA4_P DMO4P	MIPI 4th data lane positive output
MCN CLKN CLK_N DCKN	MIPI clock negative output
MCP CLKP MCP CLK_P DCKN	MIPI clock positive output
DVP Parallel Interface	
D0 DO0 Y0	DVP data output port 0
D1 DO1 Y1	DVP data output port 1
D2 DO2 Y2	DVP data output port 2
D3 DO3 Y3	DVP data output port 3
D4 DO4 Y4	DVP data output port 4
D5 DO5 Y5	DVP data output port 5
D6 DO6 Y6	DVP data output port 6
D7 DO7 Y7	DVP data output port 7
D8 DO8 Y8	DVP data output port 8
D9 DO9 Y9	DVP data output port 9
D10 DO10 Y10	DVP data output port 10
D11 DO11 Y11	DVP data output port 11

Camera Reliability Test

Reliability Inspection Item			Testing Method	Acceptance Criteria
Category		Item		
Environmental	Storage Temperature	High 60°C 96 Hours	Temperature Chamber	No Abnormal Situation
		Low -20°C 96 Hours	Temperature Chamber	No Abnormal Situation
	Operation Temperature	High 60°C 24 Hours	Temperature Chamber	No Abnormal Situation
		Low -20°C 24 Hours	Temperature Chamber	No Abnormal Situation
	Humidity	60°C 80% 24 Hours	Temperature Chamber	No Abnormal Situation
	Thermal Shock	High 60°C 0.5 Hours Low -20°C 0.5 Hours Cycling in 24 Hours	Temperature Chamber	No Abnormal Situation
Physical	Drop Test (Free Falling)	Without Package 60cm	10 Times on Wood Floor	Electrically Functional
		With Package 60cm	10 Times on Wood Floor	Electrically Functional
	Vibration Test	50Hz X-Axis 2mm 30min	Vibration Table	Electrically Functional
		50Hz Y-Axis 2mm 30min	Vibration Table	Electrically Functional
		50Hz Z-Axis 2mm 30min	Vibration Table	Electrically Functional
	Cable Tensile Strength Test	Loading Weight 4 kg 60 Seconds Cycling in 24 Hours	Tensile Testing Machine	Electrically Functional
Electrical	ESD Test	Contact Discharge 2 KV	ESD Testing Machine	Electrically Functional
		Air Discharge 4 KV	ESD Testing Machine	Electrically Functional
	Aging Test	On/Off 30 Seconds Cycling in 24 Hours	Power Switch	Electrically Functional
	USB Connector	On/Off 250 Times	Plug and Unplug	Electrically Functional



Inspection Item			Inspection Method	Standard of Inspection	
Category		Item			
Appearance	FPC/ PCB	Color	The Naked Eye	Major Difference is Not Allowed.	
		Be Torn/Chopped	The Naked Eye	Copper Crack Exposure is Not Allowed.	
		Marking	The Naked Eye	Clear, Recognizable (Within 30cm Distance)	
	Holder	Scratches	The Naked Eye	The Inside Crack Exposure is Not Allowed	
		Gap	The Naked Eye	Meet the Height Standard	
		Screw	The Naked Eye	Make Sure Screws Are Presented (If Any)	
		Damage	The Naked Eye	The Inside Crack Exposure is Not Allowed	
	Lens	Scratch	The Naked Eye	No Effect On Resolution Standard	
		Contamination	The Naked Eye	No Effect On Resolution Standard	
		Oil Film	The Naked Eye	No Effect On Resolution Standard	
		Cover Tape	The Naked Eye	No Issue On Appearance.	
	Function	Image	No Communication	Test Board	Not Allowed
			Bright Pixel	Black Board	Not Allowed In the Image Center
Dark Pixel			White board	Not Allowed In the Image Center	
Blurry			The Naked Eye	Not Allowed	
No Image			The Naked Eye	Not Allowed	
Vertical Line			The Naked Eye	Not Allowed	
Horizontal Line			The Naked Eye	Not Allowed	
Light Leakage			The Naked Eye	Not Allowed	
Blinking Image			The Naked Eye	Not Allowed	
Bruise			Inspection Jig	Not Allowed	
Resolution			Chart	Follows Outgoing Inspection Chart Standard	
Color			The Naked Eye	No Issue	
Noise			The Naked Eye	Not Allowed	
Corner Dark			The Naked Eye	Less Than 100px By 100px	
Color Resolution			The Naked Eye	No Issue	
Dimension			Height	The Naked Eye	Follows Approval Data Sheet
		Width	The Naked Eye	Follows Approval Data Sheet	
		Length	The Naked Eye	Follows Approval Data Sheet	
		Overall	The Naked Eye	Follows Approval Data Sheet	

KLT Package Solutions

KLT Camera Module



Complete with Lens Protection Film



Tray with Grid and Space



Place Cameras on the Tray



Camera Modules Package Solution

Full Tray of Cameras



Cover Tray with Lid



Put Tray into Anti-Static Bag



Vacuum the Anti-Static Bag



Camera Modules Package Solution

Sealed Vacuum Bag with Labels

1. Model and Description 2. Quantity 3. Shipping Date 4. Caution



Large Order Package Solution

Place Foam Sheets Between Trays



Foam Sheets are Slightly Larger than Trays



Place Foam Sheets and Trays into Box



Foam Sheets are Tightly Fitting Box



Small Order Package Solution

Place Foam Sheets and Trays into Small Box



Foam Sheets are Nicely Fitting the Small Box



Package in Small Box for Shipment



Place Small Boxes into Larger Box



Carbon Box Package Solution

Seal the Carbon Box

Final Package Labelled Box



Carbon Box Ready for Shipment

1. Delivery Address and Phone No. 2. Box No. and Ship Date 3. Fragile Caution



Sample Order Package Solution

Place Sample into Small Anti-Static Bag



Place Connectors into Small Ant-Static Bag



Sample Labels on the Small Bag

1. Camera Module or Connector Model 2. Shipping Date and Quantity 3. Caution



Connectors Large Order Package Solution

Connectors in a Wheel



Label Connectors in the Wheel



The Wheel is Perfectly Fitting the Box



Connectors Box Ready for Shipment





CMOS CAMERA MODULES



your BEST camera module partner

Company Kai Lap Technologies (KLT)

Kai Lap Technologies Group Limited. (KLT) was established in 2009, a next-generation technology driven manufacturer specialized in research, design, and produce of audio and video products. KLT is occupying 20,000 square feet automated plants with 100 employees of annual throughput 30,000,000 units cameras.

KLT provides OEM, ODM design, contract manufacturing, and builds the camera products. You may provide the requirements to us, even with a hand draft, our sales and engineering work together to meet your needs. We consider ourselves your last-term partner in developing practical and innovative solutions.

Our team covers everything from initial concept development to mass produced product. KLT specializes in customized camera design, raw material, electronic engineering, firmware/software development, product testing, and packing design. Our experienced strategic supply systems offer a robust and dependable manufacturing capacity for orders of various sizes.



Limited Warranty

KLT provides the following limited warranty if you purchased the Product(s) directly from KLT company or from KLT's website, www.KaiLapTech.com. Product(s) purchased from other sellers or sources are not covered by this Limited Warranty. KLT guarantees that the Product(s) will be free from defects in materials and workmanship under normal use for a period of one (1) year from the date you receive the product ("Warranty Period").

For all Product(s) that contain or develop material defects in materials or workmanship during the Warranty Period, KLT will, at its sole option, either: (i) repair the Product(s); (ii) replace the Product(s) with a new or refurbished Product(s) (replacement Product(s) being of identical model or functional equivalent); or (iii) provide you a refund of the price you paid for the Product(s).

This Limited Warranty of KLT is solely limited to repair and/or replacement on the terms set forth above. KLT is not reliable or responsible for any subsequent events.



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KLT Strength

Powerful Factory



Professional Service



Promised Delivery



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